

# EUDAS-3.579545M TR

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## REGULATORY COMPLIANCE (Data Sheet downloaded on Oct 16, 2017)


[Click badges to download compliance docs](#)

Regulatory Compliance standards are subject to updates by governing bodies. Click the badges to download the latest compliance docs for this part number directly from Ecliptek.



## ITEM DESCRIPTION

Quartz Crystal Resonator HC49/U Thru-Hole Metal Resistance Weld Seal 3.579545MHz  $\pm 30$ ppm at 25°C,  $\pm 50$ ppm over 0°C to +70°C Series Resonant

## ELECTRICAL SPECIFICATIONS

|                               |                                                      |
|-------------------------------|------------------------------------------------------|
| Nominal Frequency             | 3.579545MHz                                          |
| Frequency Tolerance/Stability | $\pm 30$ ppm at 25°C, $\pm 50$ ppm over 0°C to +70°C |
| Aging at 25°C                 | $\pm 5$ ppm/year Maximum                             |
| Load Capacitance              | Series Resonant                                      |
| Shunt Capacitance             | 7pF Maximum                                          |
| Equivalent Series Resistance  | 180 Ohms Maximum                                     |
| Mode of Operation             | AT-Cut Fundamental                                   |
| Drive Level                   | 2mWatts Maximum                                      |
| Storage Temperature Range     | -40°C to +125°C                                      |
| Insulation Resistance         | 500 Megaohms Minimum (Measured at 100Vdc)            |

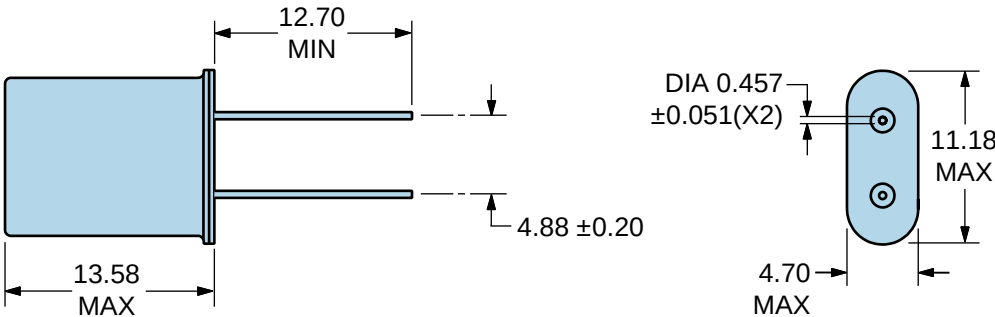
## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                              |                                               |
|------------------------------|-----------------------------------------------|
| ESD Susceptibility           | MIL-STD-883, Method 3015, Class 1, HBM: 1500V |
| Fine Leak Test               | MIL-STD-883, Method 1014, Condition A         |
| Flammability                 | UL94-V0                                       |
| Gross Leak Test              | MIL-STD-883, Method 1014, Condition C         |
| Lead Integrity               | MIL-STD-883, Method 2004                      |
| Mechanical Shock             | MIL-STD-202, Method 213, Condition C          |
| Moisture Resistance          | MIL-STD-883, Method 1004                      |
| Moisture Sensitivity         | J-STD-020, MSL1                               |
| Resistance to Soldering Heat | MIL-STD-202, Method 210, Condition K          |
| Resistance to Solvents       | MIL-STD-202, Method 215                       |
| Solderability                | MIL-STD-883, Method 2003                      |
| Temperature Cycling          | MIL-STD-883, Method 1010, Condition B         |
| Vibration                    | MIL-STD-883, Method 2007, Condition A         |

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MECHANICAL DIMENSIONS (all dimensions in millimeters)



| LINE | MARKING                                           |
|------|---------------------------------------------------|
| 1    | ECLIPTEK                                          |
| 2    | E3.5795M<br><i>E=Configuration Designator</i>     |
| 3    | XX<br><i>XX=Ecliptek Manufacturing Identifier</i> |

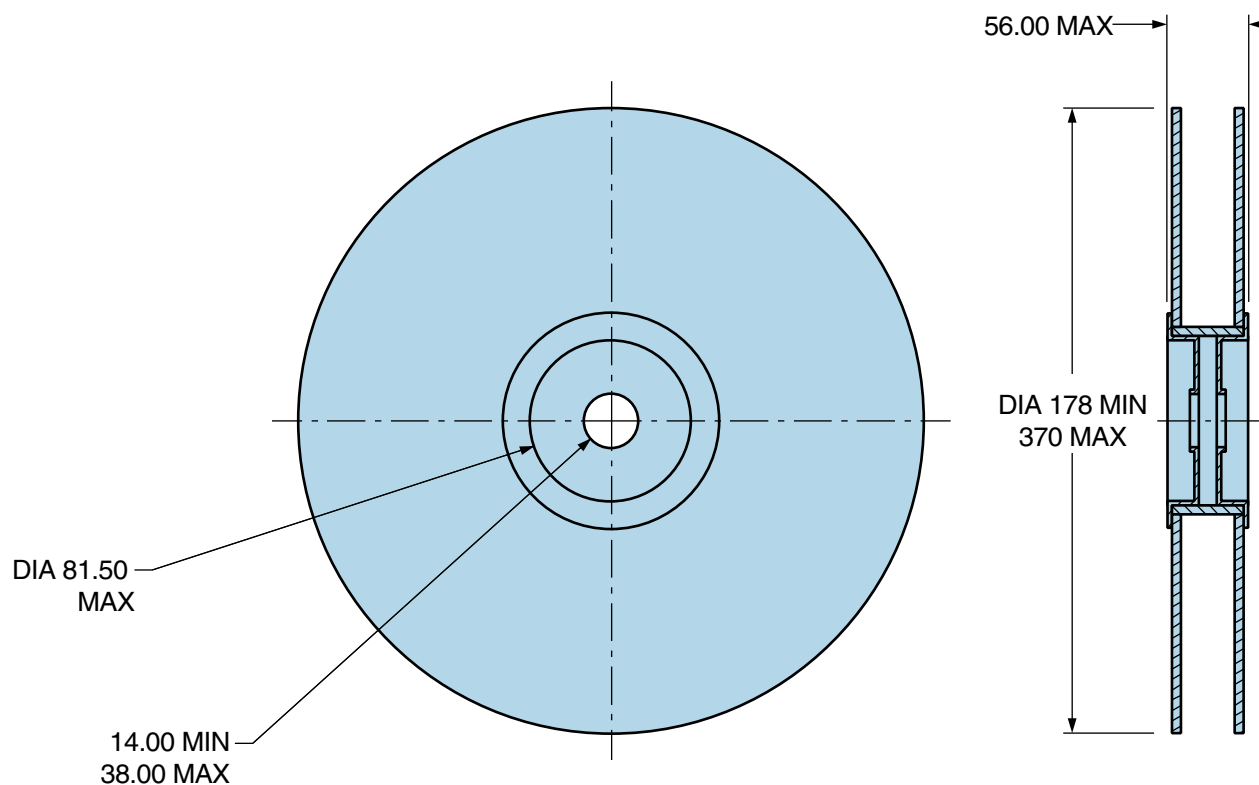
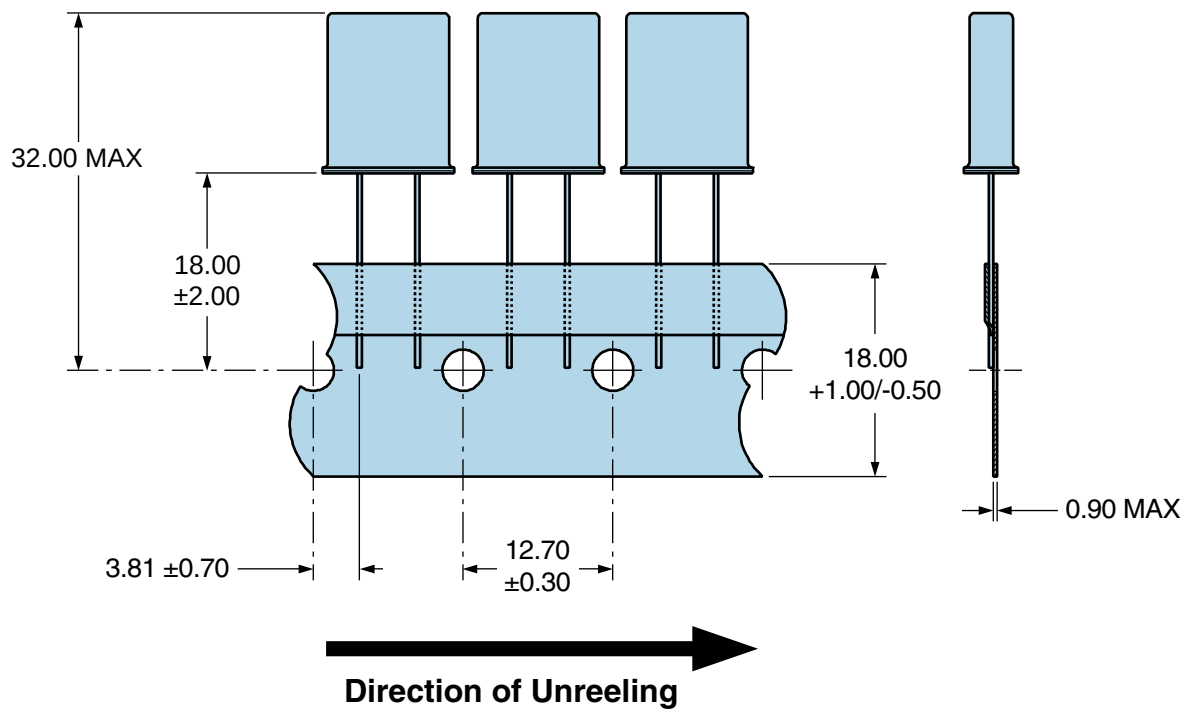
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## Tape & Reel Dimensions

Quantity Per Reel: 1,000 units

All Dimensions in Millimeters

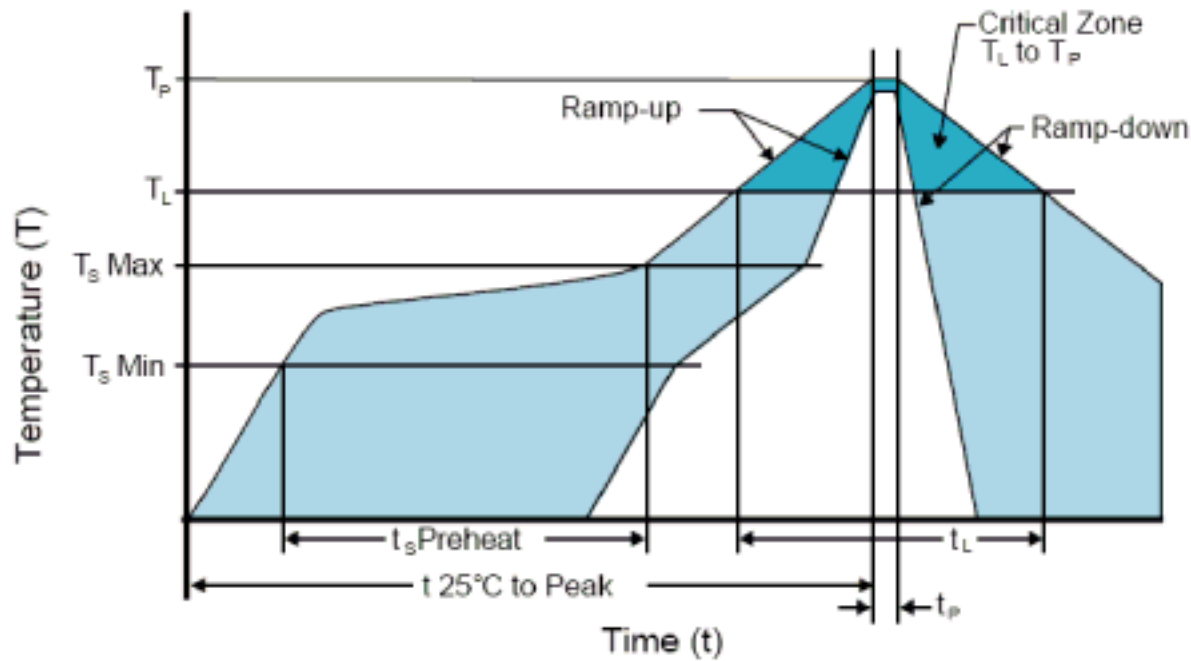
Compliant to EIA-468



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Recommended Solder Reflow Methods



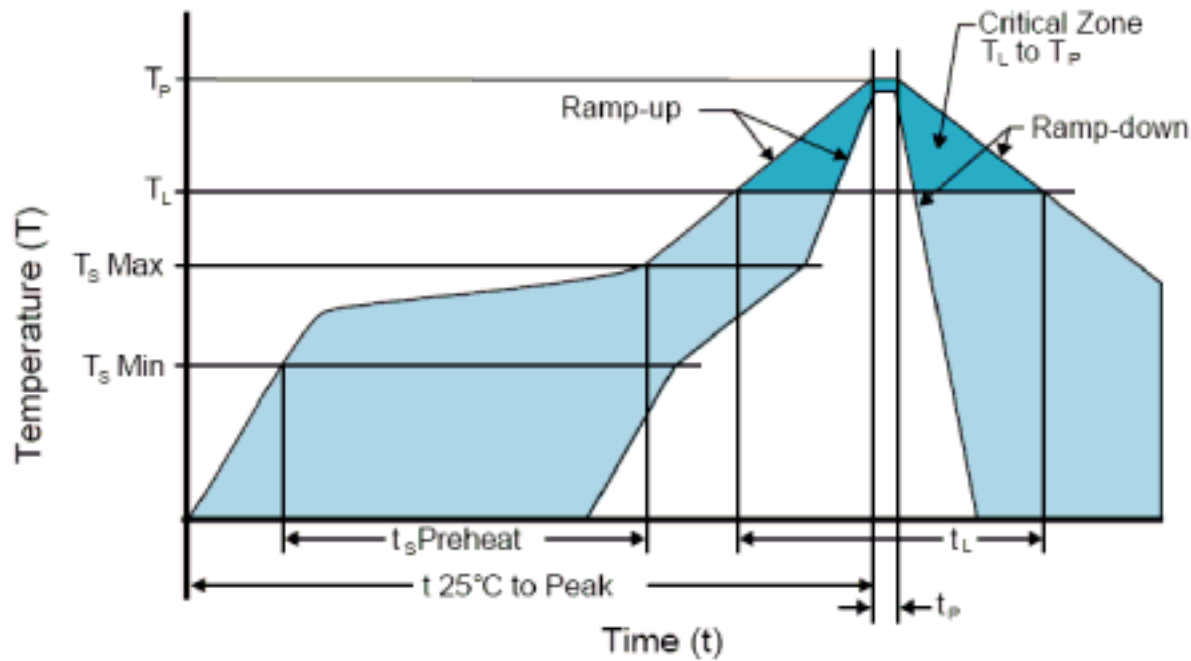
High Temperature Solder Bath (Wave Solder)

|                                                                |                                                                            |
|----------------------------------------------------------------|----------------------------------------------------------------------------|
| <b><math>T_s</math> MAX to <math>T_L</math> (Ramp-up Rate)</b> | 3°C/Second Maximum                                                         |
| <b>Preheat</b>                                                 |                                                                            |
| - Temperature Minimum ( $T_s$ MIN)                             | 150°C                                                                      |
| - Temperature Typical ( $T_s$ TYP)                             | 175°C                                                                      |
| - Temperature Maximum ( $T_s$ MAX)                             | 200°C                                                                      |
| - Time ( $t_s$ MIN)                                            | 60 - 180 Seconds                                                           |
| <b>Ramp-up Rate (<math>T_L</math> to <math>T_P</math>)</b>     | 3°C/Second Maximum                                                         |
| <b>Time Maintained Above:</b>                                  |                                                                            |
| - Temperature ( $T_L$ )                                        | 217°C                                                                      |
| - Time ( $t_L$ )                                               | 60 - 150 Seconds                                                           |
| <b>Peak Temperature (<math>T_P</math>)</b>                     | 260°C Maximum for 10 Seconds Maximum                                       |
| <b>Target Peak Temperature (<math>T_P</math> Target)</b>       | 250°C +0/-5°C                                                              |
| <b>Time within 5°C of actual peak (<math>t_P</math>)</b>       | 20 - 40 Seconds                                                            |
| <b>Ramp-down Rate</b>                                          | 6°C/Second Maximum                                                         |
| <b>Time 25°C to Peak Temperature (t)</b>                       | 8 Minutes Maximum                                                          |
| <b>Moisture Sensitivity Level</b>                              | Level 1                                                                    |
| <b>Additional Notes</b>                                        | Temperatures shown are applied to back of PCB board and device leads only. |

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Recommended Solder Reflow Methods



Low Temperature Solder Bath (Wave Solder)

|                                     |                                                                            |
|-------------------------------------|----------------------------------------------------------------------------|
| Ts MAX to TL (Ramp-up Rate)         | 5°C/Second Maximum                                                         |
| Preheat                             |                                                                            |
| - Temperature Minimum (Ts MIN)      | N/A                                                                        |
| - Temperature Typical (Ts TYP)      | 150°C                                                                      |
| - Temperature Maximum (Ts MAX)      | N/A                                                                        |
| - Time (ts MIN)                     | 30 - 60 Seconds                                                            |
| Ramp-up Rate (TL to TP)             | 5°C/Second Maximum                                                         |
| Time Maintained Above:              |                                                                            |
| - Temperature (TL)                  | 150°C                                                                      |
| - Time (tL)                         | 200 Seconds Maximum                                                        |
| Peak Temperature (TP)               | 245°C Maximum                                                              |
| Target Peak Temperature (TP Target) | 245°C Maximum 1 Time / 235°C Maximum 2 Times                               |
| Time within 5°C of actual peak (tp) | 5 Seconds Maximum 1 Time / 15 Seconds Maximum 2 Times                      |
| Ramp-down Rate                      | 5°C/Second Maximum                                                         |
| Time 25°C to Peak Temperature (t)   | N/A                                                                        |
| Moisture Sensitivity Level          | Level 1                                                                    |
| Additional Notes                    | Temperatures shown are applied to back of PCB board and device leads only. |

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to back of PCB board and device leads only.)

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to back of PCB board and device leads only.)